## 查<u>询"FDD5N50NZF"</u>供应商

FAIRCHILD

SEMICONDUCTOR®

## **FDD5N50NZF N-Channel MOSFET** 500V, 3.7A, 1.75Ω

## Features

- $R_{DS(on)} = 1.47\Omega (Typ.) @ V_{GS} = 10V, I_D = 1.85A$
- Low Gate Charge (Typ. 9nC)
- Low C<sub>rss</sub> ( Typ. 4pF)
- Fast Switching
- 100% Avalanche Tested
- Improved dv/dt Capability
- ESD Imoroved Capability
- RoHS Compliant

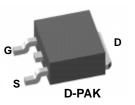


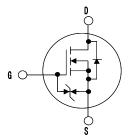
## November 2009 UniFET-II<sup>™</sup>

## Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advance technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficient switching mode power supplies and active power factor correction.





## MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

Symbol		FDD5N50NZF	Units			
V <sub>DSS</sub>	Drain to Source Voltage			500	V	
V <sub>GSS</sub>	Gate to Source Voltage			±25	V	
	Droin Current	-Continuous ( $T_C = 25^{\circ}C$ )		3.7	A	
I <sub>D</sub>	Drain Current	-Continuous ( $T_C = 100^{\circ}C$ )		2.2		
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 1)	14	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 2)	165	mJ	
I <sub>AR</sub>	Avalanche Current		(Note 1)	3.3	А	
E <sub>AR</sub>	Repetitive Avalanche Energy		(Note 1)	6.25	mJ	
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	15	V/ns	
P <sub>D</sub>	Dower Dissinction	$(T_{C} = 25^{\circ}C)$		62.5	W	
	Power Dissipation	- Derate above 25°C		0.5	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering Purpose, 1/8" from Case for 5 Seconds			300	°C	

## Thermal Characteristics

Symbol	Parameter	FDD5N50NZF	Units	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case	2	°C/W	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient	62.5		

Device Marking FDD5N50NZF		Device	Package	Reel Size	Tap	e Width		Quantit	v
		FDD5N50NZFTM	D-PAK			6mm	2500		
	-	racteristics T <sub>c</sub> =							
Symbol		Parameter	25°C unless our	Test Condition	26	Min.	Тур.	Max.	Units
Off Charac	teristic			Test Condition	13		iyp.	Wax.	Onita
BV <sub>DSS</sub>	-	o Source Breakdown Vo	ltage Ir	<sub>0</sub> = 250μA, V <sub>GS</sub> = 0V, T	c = 25°C	500	-	-	V
ΔBV <sub>DSS</sub> ΔT.I	Breakd	Breakdown Voltage Temperature Coefficient		$I_D = 250\mu$ A, Referenced to $25^{\circ}$ C		-	0.5	-	V/°C
				$V_{DS} = 500V, V_{GS} = 0V$ $V_{DS} = 400V, V_{GS} = 0V, T_C = 125^{\circ}C$		-	-	10	μA
DSS	SS Zero Gate Volta		nt			-	-	100	
GSS	Gate to Body Leakage Current		. V	$_{GS} = \pm 25 \text{V}, \text{V}_{DS} = 0 \text{V}$	-	-	-	±10	μA
On Charac	teristic	S							
V <sub>GS(th)</sub>	Gate T	hreshold Voltage	V	<sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA		3.0	-	5.0	V
R <sub>DS(on)</sub>		Drain to Source On Resi		$I_{GS} = 10V, I_D = 1.85A$		-	1.47	1.75	Ω
JFS		d Transconductance		<sub>DS</sub> = 20V, I <sub>D</sub> = 1.85A	(Note 4)	-	4.2	-	S
Dynamic C	haract	eristics							
C <sub>iss</sub>	Input C	apacitance					365	485	pF
C <sub>oss</sub>	Output	Capacitance		′ <sub>DS</sub> = 25V, V <sub>GS</sub> = 0V = 1MHz		-	50	65	pF
C <sub>rss</sub>	Revers	e Transfer Capacitance		- 1101112		-	4	8	pF
Q <sub>g(tot)</sub>	Total G	ate Charge at 10V				-	9	12	nC
ୁ C <sub>gs</sub>	Gate to	Source Gate Charge		$V_{DS} = 400 V I_D = 3.7 A$ $V_{GS} = 10 V$ (Note		-	2	-	nC
ସ <sub>gd</sub>	Gate to	Drain "Miller" Charge	V			-	4	-	nC
Switching	Charac	teristics							
d(on)	-	n Delay Time				-	12	35	ns
r	Turn-O	n Rise Time		<sub>DD</sub> = 250V, I <sub>D</sub> = 3.7A	-	-	19	50	ns
d(off)	Turn-O	ff Delay Time	V	$V_{GS}$ = 10V, $R_{GEN}$ = 25 $\Omega$		-	31	70	ns
f	Turn-O	ff Fall Time			(Note 4, 5)	-	22	55	ns
Drain-Sou	rce Dio	de Characteristics	5						
Is	Maximum Continuous Drain to Source Diode Forward Current				-	-	3.7	Α	
SM	Maximum Pulsed Drain to Source Diode Fo		ce Diode Forwa	orward Current		-	-	14	Α
V <sub>SD</sub>	Drain to	Source Diode Forward	Voltage V	<sub>GS</sub> = 0V, I <sub>SD</sub> = 3.7A		-	-	1.5	V
t <sub>rr</sub>	Reverse	e Recovery Time	V	<sub>GS</sub> = 0V, I <sub>SD</sub> = 3.7A		-	87	-	ns
Q <sub>rr</sub>	Boyoro	e Recovery Charge		$dI_{F}/dt = 100A/\mu s$			0.15		μC

2. L = 23mH, I\_{AS} = 3.7A, V\_{DD} = 50V, R\_G = 25  $\Omega$ , Starting T\_J = 25  $^{\circ}\text{C}$ 

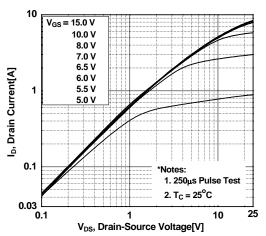
3.  $I_{SD} \le 3.7A$ , di/dt  $\le 200A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ , Starting  $T_J = 25^{\circ}C$ 

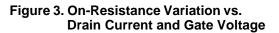
4. Pulse Test: Pulse width  $\leq$  300 $\mu$ s, Dual Cycle  $\leq$  2%

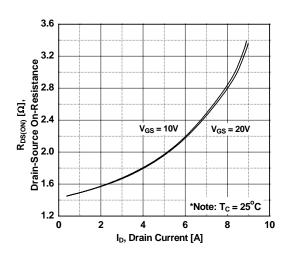
5. Essentially Independent of Operating Temperature Typical Characteristics

### 查询"FDD5N50NZF"供应商 Typical Performance Characteristics











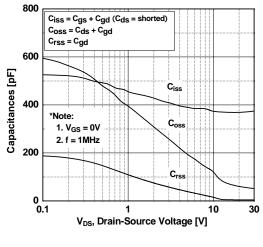
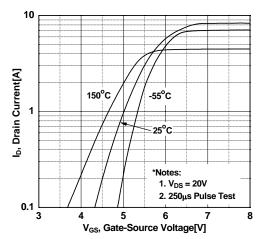
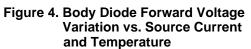


Figure 2. Transfer Characteristics





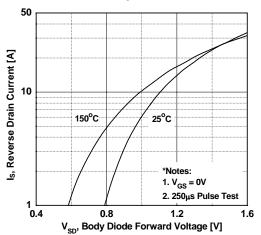
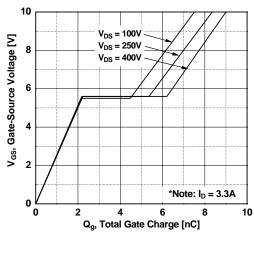
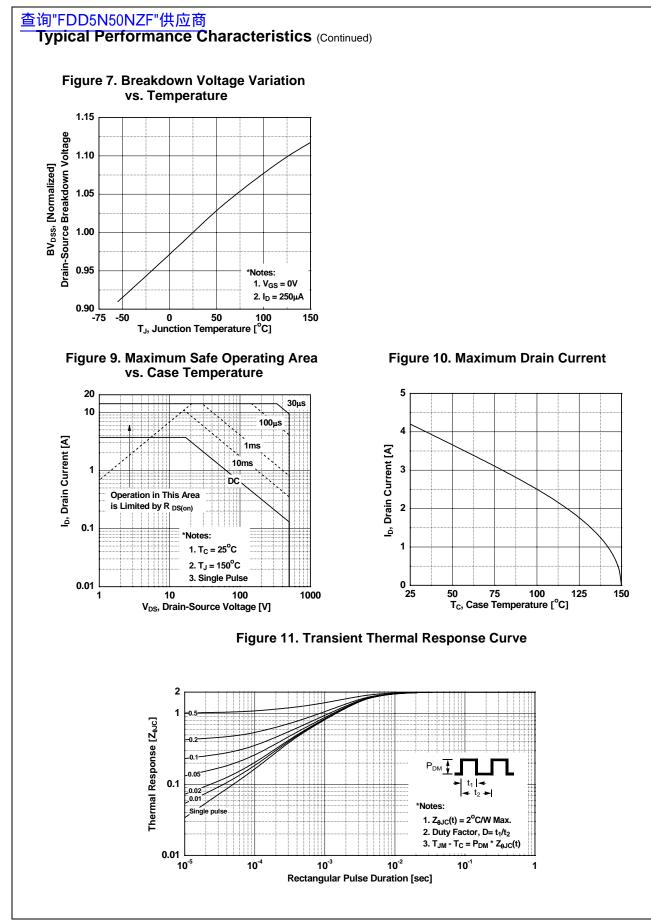
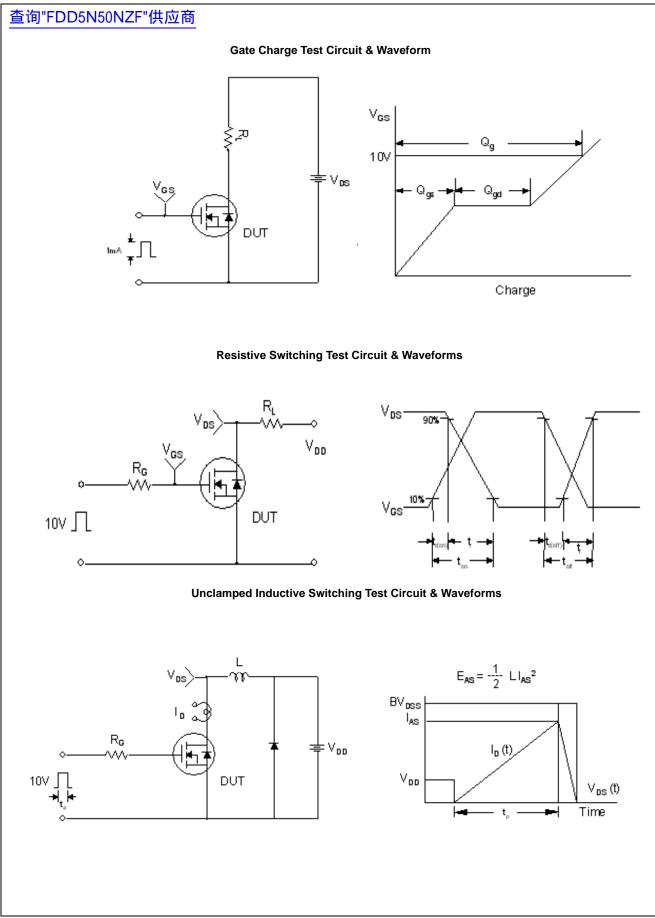


Figure 6. Gate Charge Characteristics





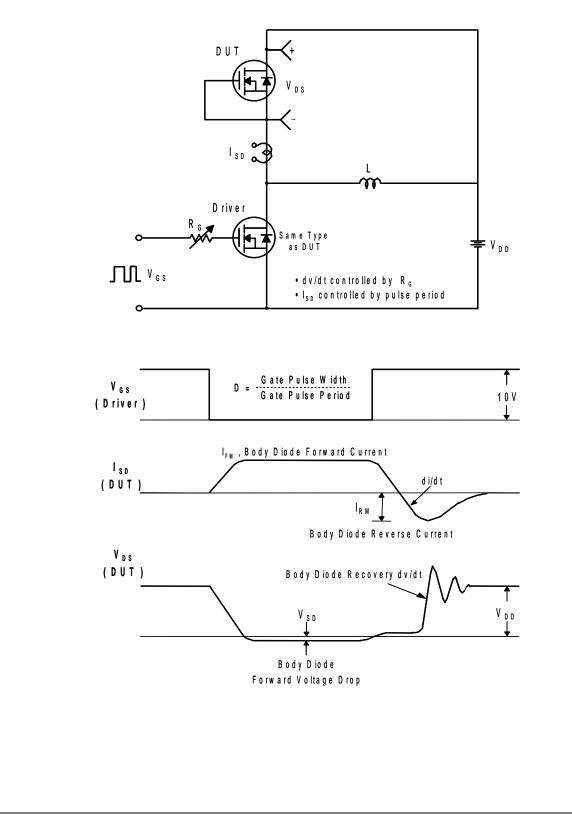
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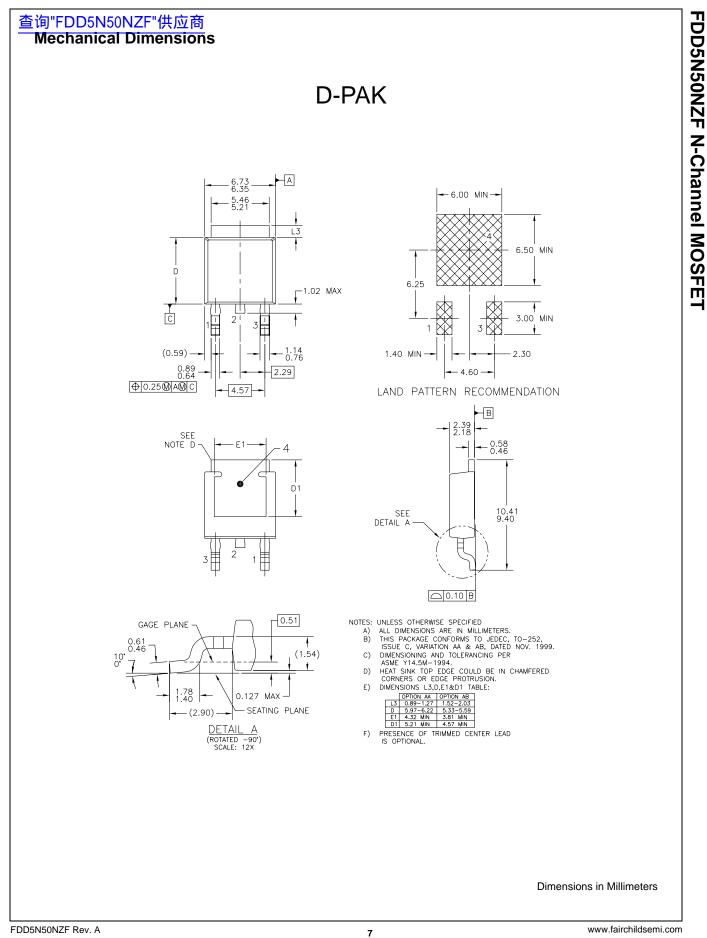


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### Peak Diode Recovery dv/dt Test Circuit & Waveforms





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